# MI1206K310R-10

# UNCONTROLLED DOCUMENT

### PHYSICAL DIMENSIONS:

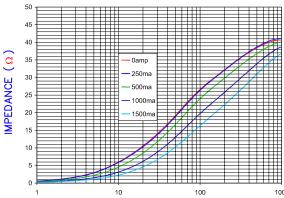
A 3.20 [.126]  $\pm$  0.20 [.008]

B 1.60 [.063] ± 0.20 [.008]

C 1.10 [.043] ± 0.20 [.008]

D 0.51 [.020] ± 0.25 [.010]

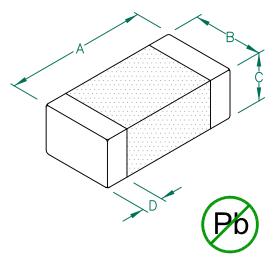
## Z vs FREQUENCY IMPEDANCE UNDER DC BIAS



## FREQUENCY (MHz)

|Z| , R, AND X vs. FREQUENCY

AGILENT E4991A RF Impedance/Material Analyzer HP 16194A Test Fixture. TEST REF. 3227

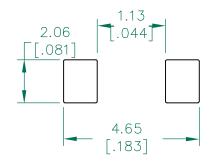


# ELECTRICAL CHARACTERISTICS:Z @ 100MHzDCRRated( $\Omega$ )CurrentNominal31Minimum23Maximum390.0451500 mA

NOTES: UNLESS OTHERWISE SPECIFIED

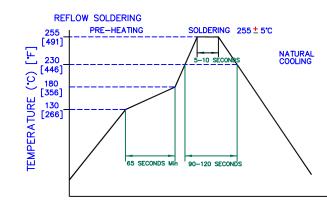
- 1. TAPED AND REELED per CURRENT EIA SPECIFICATIONS 7" REELS, 3000 PCS/REEL.
- 2. COMPONENTS SHOULD BE ADEQUATELY PREHEATED BEFORE SOLDERING.
- 3. TERMINATION FINISH IS 100% TIN.
- 4. OPERATING TEMP. RANGE: -40°C~+125°C. (INCLUDING SELF-HEATING)

#### LAND PATTERNS FOR REFLOW SOLDERING



(For wave soldering, add 0.762 (.030) to this dimension)

#### RECOMMENDED SOLDERING CONDITIONS





DIMENSIONS ARE IN mm [INCHES].				This print is the property of Laird			
	-			Tech. and is loaned in confidence			<b>.</b> I'
				subject to return upon request and with the understanding that no	Laird		
				copies shall be made without the			
				written consent of Laird Tech. All			
				rights to design or invention are reserved.			
		l					
	ADD ODEDATING TEMPERATURE				REV	PART TYPE:	DRAWN BY:
С	ADD OPERATING TEMPERATURE UPDATE LAIRD LOGO AND REFLOW CURVE	08/05/13	QU	MI1206K310R-10	С	CO-FIRE	JRK
В	UPDATE COMPANY LOGO ADD ROHS	8/22/08	IDV	DATE: 04 /4 7 /04 SC/	ALE:		
				DATE: 04/13/04	NTS SHEET:		
A	ORIGINAL DRAFT	04/13/04	JRK	, ,	OL #		
REV	DESCRIPTION	DATE	INT		u	-   2	of 2